**Features** 



## **Battery Switch with Four Enable Inputs**

#### **General Description**

The MAX14525 features a low  $R_{ON}$  35m $\Omega$  (typ) load switch with four unique enable inputs. The MAX14525 is ideal for disconnecting the lithium-ion (Li+) battery from the loads in portable devices such as cell phones. The MAX14525 operates from a +2.2V to +5.5V supply voltage.

The MAX14525 features an extremely low 0.8µA (typ) quiescent supply current to maximize battery life in portable devices. It is enabled from four possible inputs: external charger connection capable of high voltage up to +28V, travel adapter (TA), on key (ON\_K), factory mode enable (JIG), and switch enable (S\_EN). The S EN input is internally ANDed with the switched battery connection (IN).

The MAX14525 is available in a small 8-pin, 2mm x 2mm TDFN package and operates over the -40°C to +85°C extended temperature range.

#### **Applications**

Cell Phones

**PDAs** 

**GPS** 

**UMPC** Computers

Digital Cameras

## ♦ Low 35mΩ (typ) Ron Load Switch

- ♦ Ultra Low, 0.8µA (typ) Supply Current
- **♦** Four Enable Inputs:

TA: +28V (max) Capable

ON K: Accurate +3V Trigger Enable

JIG: Factory Mode Enable S\_EN: Logically ANDed with IN

- ♦ Space-Saving 8-Pin, 2mm x 2mm TDFN Package
- ♦ Controlled Turn-On to Limit dl/dt Pulses Due to **Lead Inductance**

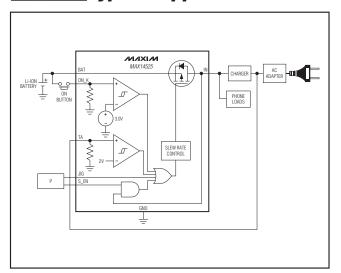
#### **Ordering Information**

PART	PIN-PACKAGE	TOP MARK		
MAX14525ETA+T	8 TDFN-EP*	ACQ		

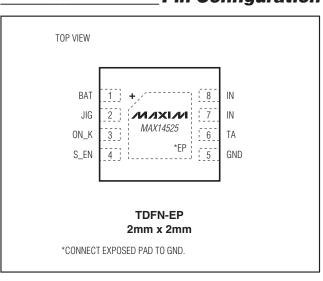
**Note:** The device is specified over the -40°C to +85°C operating temperature range.

+Denotes a lead-free/RoHS-compliant package.

#### **Typical Application Circuit**



## Pin Configuration



Maxim Integrated Products 1

<sup>\*</sup>EP = Exposed pad.

#### **ABSOLUTE MAXIMUM RATINGS**

(All voltages referenced to GND.)	Junction-to-Ambient Thermal Resistance
IN, BAT, JIG, S_EN, ON_K0.3V to +6.0V	(θJA) (Note 1)84°C/W
TA0.3V to +28V	Operating Temperature Range40°C to +85°C
Continuous Power Dissipation (T <sub>A</sub> = +70°C)	Junction Temperature +150°C
8-Pin TDFN (derate 11.9 mW/°C above +70°C)954 mW	Storage Temperature Range65°C to +150°C
Junction-to-Case Thermal Resistance	Lead Temperature (soldering, 10s)+300°C
(θ <sub>JC</sub> ) (Note 1)37°C/W	

**Note 1:** Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <a href="https://www.maxim-ic.com/thermal-tutorial">www.maxim-ic.com/thermal-tutorial</a>.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

 $(V_{BAT} = +2.2V \text{ to } +5.5V, T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical values are at  $V_{BAT} = +3.6V$  and  $T_A = +25^{\circ}\text{C}.)$  (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DC CHARACTERISTICS			•			•
Input Voltage Range	V <sub>BAT</sub> , V <sub>IN</sub>		2.2		5.5	V
On-Resistance	Ron	$I_{LOAD} = 100$ mA, $V_{BAT} = +3.0$ V		35	90	mΩ
Disable Supply Current	I <sub>BAT_DIS</sub>	$V_{BAT} = +5.5V$ $(V_{JIG} = V_{S\_EN} = V_{ON\_K} = V_{TA} = V_{IN} = 0)$			1	μΑ
V <sub>BAT</sub> Supply Current	I <sub>BAT</sub>	$V_{JIG} = V_{S\_EN} = V_{BAT}$ , $V_{ON\_K} = V_{TA} = 0$		0.8	4.5	μΑ
Increase in Supply Current with V <sub>JIG</sub> /V <sub>S_EN</sub> Voltage	Δl <sub>BAT</sub>	V <sub>JIG</sub> = V <sub>S_EN</sub> = V <sub>IH</sub> or V <sub>IL</sub>			2	μΑ
Increase in Supply Current with V <sub>ON_K</sub> Voltage	$\Delta I_{BAT}$	$V_{BAT} = V_{ON\_K} = +3.6V$			4.5	μΑ
Peak Current	I <sub>LIM</sub>	V <sub>BAT</sub> = +3.6V	5			А
UVLO Undervoltage Lockout		Ramping V <sub>BAT</sub>			1.9	V
LOGIC INPUT						
TA Threshold Voltage	V <sub>TA_TH</sub>		1.15	1.7	2.5	V
TA Threshold Hysteresis				1%		
TA Input Resistance		V <sub>TA</sub> = 1V	50	100	180	kΩ
JIG, S_EN Input Logic-High	VIH		1.4			V
JIG, S_EN Input Logic-Low	VIL				0.4	V
JIG, S_EN Input Leakage Current	I <sub>IN</sub>	$V_{BAT} = +5.5V$	-200		+200	nA
IN AND Gate Threshold Voltage	V <sub>IN_TH</sub>		0.3 x V <sub>BAT</sub>		0.6 x V <sub>BAT</sub>	V
ON_K Threshold Voltage	Von_k_th	Low-to-high transition (Figure 1)	2.94	3.0	3.06	V
ON_K Threshold Hysteresis				1%		

#### **ELECTRICAL CHARACTERISTICS (continued)**

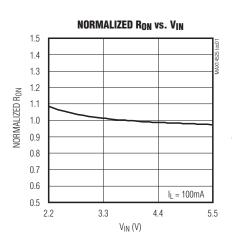
( $V_{BAT}$  = +2.2V to +5.5V,  $T_A$  = -40°C to +85°C, unless otherwise noted. Typical values are at  $V_{BAT}$  = +3.6V and  $T_A$  = +25°C.) (Note 2)

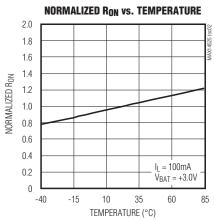
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
ON_K Input Leakage Current	ION_K	$V_{BAT} = V_{ON}_{K} = +3.6V$			3	μΑ
SWITCH DYNAMICS (R <sub>L</sub> = $20\Omega$ , C <sub>L</sub> = $0.1\mu$ F) (Figure 2)						
Turn-On Delay Time	tondly	From any enable high to V <sub>IN</sub> = 10% of V <sub>BAT</sub>		600	2600	μs
Turn-On Rise Time	tonrise	V <sub>IN</sub> 10% to 90% of V <sub>BAT</sub>	500	1800	5000	μs
Turn-Off Delay Time	toffdly	From any enable low to V <sub>IN</sub> = 90% of V <sub>BAT</sub>		130	300	μs
Turn-Off Fall Time	tofffall	V <sub>IN</sub> 90% to 10% of V <sub>BAT</sub>		60	150	μs

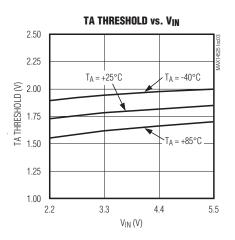
**Note 2:** Devices are tested at  $T_A = +25$ °C. Specifications over temperature are guaranteed by design.

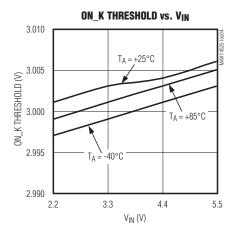
## **Typical Operating Characteristics**

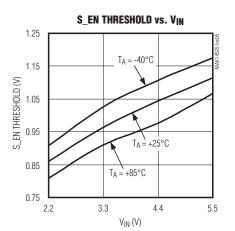
 $(V_{IN} = +3.6V, T_A = +25^{\circ}C, unless otherwise noted.)$ 





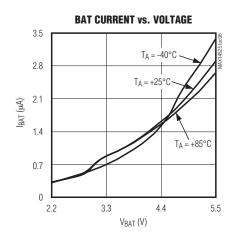


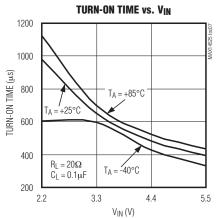


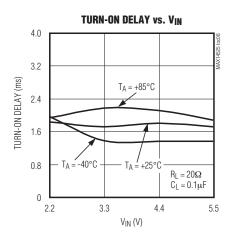


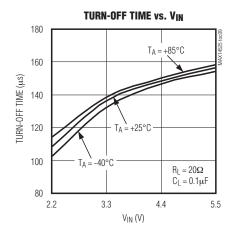
## \_Typical Operating Characteristics (continued)

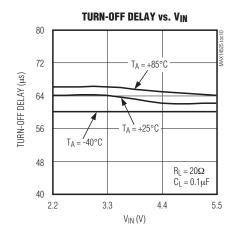
 $(V_{IN} = +3.6V, T_A = +25^{\circ}C, \text{ unless otherwise noted.})$ 

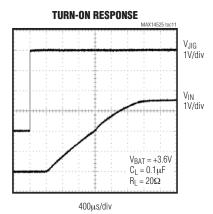


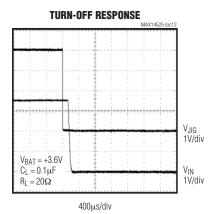












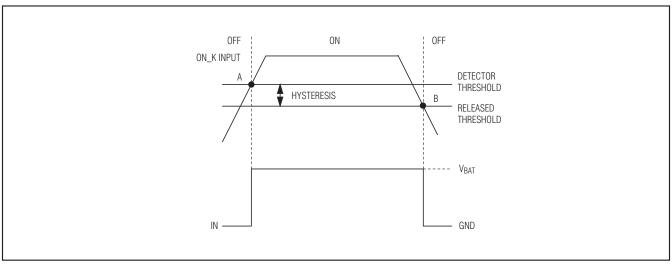


Figure 1. ON\_K Input Operation Diagram

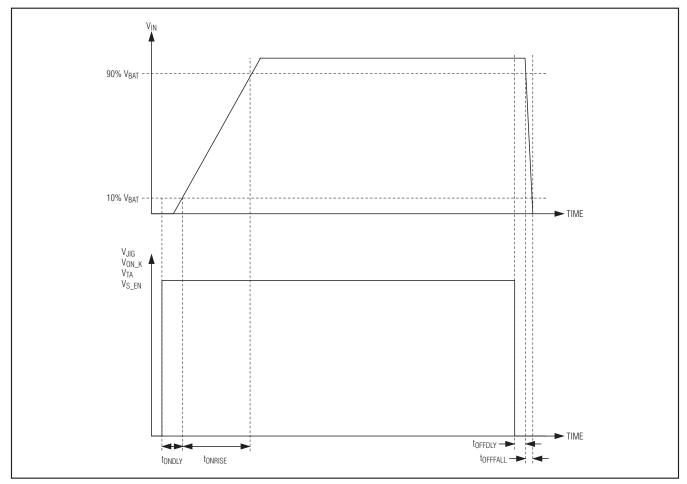


Figure 2. Turn-On Delay Time, Turn-On Rise Time, Turn-Off Delay Time, and Turn-Off Fall Time

#### **Pin Description**

PIN	NAME	FUNCTION	
1	BAT	Lithium-lon (Li+) Battery Connection	
2	JIG	Enable Input with Standard Logic Threshold	
3	ON_K	Enable Input with Accurate Threshold (+3.0V)	
4	S_EN	Enable Input with Standard Logic Threshold Logically ANDed with IN	
5	GND	Ground	
6	TA	Enable Input with High Threshold	
7, 8	IN	Power Switch Input. The power switch input voltage range is from +2.2V to +5.5V. Connect a 0.1µF capacitor from IN to GND. Connect pins 7 and 8 together for proper operation.	
_	EP	Exposed Pad. Connect EP to ground. Do not use EP as the only ground connection.	

### **Detailed Description**

The MAX14525 features a low  $35m\Omega$  (typ) R<sub>ON</sub> load switch with four unique enable inputs. The MAX14525 can be used to disconnect the lithium-ion battery from the loads in portable devices such as cell phones. It operates from a +2.2V to +5.5V supply voltage.

The MAX14525 features an ultra-low 0.8µA (typ) quiescent supply current to maximize battery life in portable devices. The device is enabled from four possible inputs: external charge connection travel adapter (TA), on key (ON\_K), factory mode enable (JIG), and switch enable (S\_EN). The S\_EN input is internally ANDed with the switched battery connection (IN).

### \_TA Input

The TA input on the MAX14525 can be connected directly to the external charger source. The TA input is high-voltage capable (+28V max) and features a high threshold voltage to limit false voltage trips, and an input resistance of  $100k\Omega$  (typ) to ground.

#### **ON K Input**

The ON\_K line is active high and is pulled up to the lithium-ion battery through a momentary push button switch. This input features an accurate voltage detector threshold which does not enable the load switch

until the battery threshold is above +3.0V ±2%. When the battery has a very low charge and the on key is pressed, the accurate threshold does not allow the phone to boot up.

### \_JIG Input

The JIG input on the MAX14525 is a logic-level input (+1.8V compatible) from an external source to indicate the device has been connected to a factory cable. This signal requires a standard logic-input threshold voltage (+1.4V high).

## S\_EN Input

The S\_EN input on the MAX14525 is a logic-level input (+1.8V compatible) from an external source used to hold the switch on when the triggering condition (TA, ON\_K, or JIG) is removed. The standard logic threshold voltage comes from the host microprocessor that pulls S\_EN high once the code has begun running on the microprocessor. The S\_EN input is internally ANDed with the voltage on IN. The IN connection to the AND gate thresholds are standard CMOS values of 1/3 and 2/3 of  $V_{\rm BAT}$ .

Chip Information

PROCESS: CMOS

## **Package Information**

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
8 TDFN-EP	T822+2	<u>21-0168</u>

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